

# Rochester Electronics Manufactured Components

Rochester branded components are manufactured using either die/wafers purchased from the original suppliers or Rochester wafers recreated from the original IP. All recreations are done with the approval of the OCM.

Parts are tested using original factory test programs or Rochester developed test solutions to guarantee product meets or exceed the OCM data sheet.

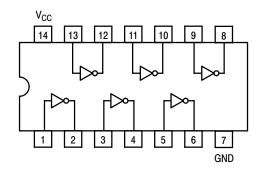
# **Quality Overview**

- ISO-9001
- AS9120 certification
- Qualified Manufacturers List (QML) MIL-PRF-35835
  - Class Q Military
  - Class V Space Level
- Qualified Suppliers List of Distributors (QSLD)
- Rochester is a critical supplier to DLA and meets all industry and DLA standards.

Rochester Electronics, LLC is committed to supplying products that satisfy customer expectations for quality and are equal to those originally supplied by industry manufacturers.

The original manufacturer's datasheet accompanying this document reflects the performance and specifications of the Rochester manufactured version of this device. Rochester Electronics guarantees the performance of its semiconductor products to the original OEM specifications. 'Typical' values are for reference purposes only. Certain minimum or maximum ratings may be based on product characterization, design, simulation, or sample testing.

# **Hex Inverter**



#### **GUARANTEED OPERATING RANGES**

Symbol	Parameter	Min	Тур	Max	Unit
V <sub>CC</sub>	Supply Voltage	4.75	5.0	5.25	V
T <sub>A</sub>	Operating Ambient Temperature Range	0	25	70	°C
I <sub>OH</sub>	Output Current - High			-0.4	mA
l <sub>OL</sub>	Output Current – Low			8.0	mA



## ON Semiconductor™

http://onsemi.com

# LOW POWER SCHOTTKY



PLASTIC N SUFFIX CASE 646



SOIC D SUFFIX CASE 751A



SOEIAJ M SUFFIX CASE 965

#### **ORDERING INFORMATION**

Device	Package	Shipping	
SN74LS04N	14 Pin DIP	2000 Units/Box	
SN74LS04D	SOIC-14	55 Units/Rail	
SN74LS04DR2	SOIC-14	2500/Tape & Reel	
SN74LS04M	SOEIAJ-14	See Note 1	
SN74LS04MEL	SOEIAJ-14	See Note 1	

 For ordering information on the EIAJ version of the SOIC package, please contact your local ON Semiconductor representative.

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#### DC CHARACTERISTICS OVER OPERATING TEMPERATURE RANGE (unless otherwise specified)

			Limits				
Symbol	Parameter	Min	Тур	Max	Unit	Test C	onditions
V <sub>IH</sub>	Input HIGH Voltage	2.0			V	Guaranteed Inp All Inputs	ut HIGH Voltage for
V <sub>IL</sub>	Input LOW Voltage			0.8	V	Guaranteed Inp All Inputs	ut LOW Voltage for
V <sub>IK</sub>	Input Clamp Diode Voltage		-0.65	-1.5	V	V <sub>CC</sub> = MIN, I <sub>IN</sub> =	= – 18 mA
V <sub>OH</sub>	Output HIGH Voltage	2.7	3.5		V	V <sub>CC</sub> = MIN, I <sub>OH</sub> or V <sub>IL</sub> per Tru	= MAX, V <sub>IN</sub> = V <sub>IH</sub> th Table
.,	0		0.25	0.4	V		$V_{CC} = V_{CC} MIN,$
V <sub>OL</sub>	Output LOW Voltage		0.35	0.5	V	I <sub>OL</sub> = 8.0 mA	$V_{IN} = V_{IL}$ or $V_{IH}$ per Truth Table
	land till City Command			20	μΑ	V <sub>CC</sub> = MAX, V <sub>IN</sub> = 2.7 V	
lіН	Input HIGH Current			0.1	mA	V <sub>CC</sub> = MAX, V <sub>IN</sub>	<sub>J</sub> = 7.0 V
I <sub>IL</sub>	Input LOW Current			-0.4	mA	V <sub>CC</sub> = MAX, V <sub>IN</sub>	J = 0.4 V
los	Short Circuit Current (Note 2)	-20		-100	mA	V <sub>CC</sub> = MAX	
	Power Supply Current						
I <sub>CC</sub>	Total, Output HIGH			2.4	mA	V <sub>CC</sub> = MAX	
	Total, Output LOW			6.6		0/2/10	

Not more than one output should be shorted at a time, nor for more than 1 second.

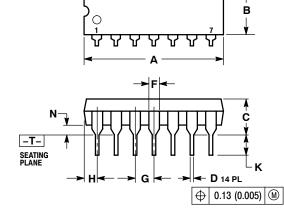
## AC CHARACTERISTICS $(T_A = 25^{\circ}C)$

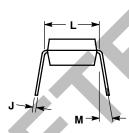
			Limits	0.7	3 6	,
Symbol	Parameter	Min	Тур	Max	Unit	Test Conditions
t <sub>PLH</sub>	Turn-Off Delay, Input to Output		9.0	15	ns	V <sub>CC</sub> = 5.0 V
t <sub>PHL</sub>	Turn-On Delay, Input to Output		10	15	ns	C <sub>L</sub> = 15 pF
	O RIFIASE CO	S P C				

#### PACKAGE DIMENSIONS

## **N SUFFIX**

PLASTIC PACKAGE CASE 646-06 ISSUE M

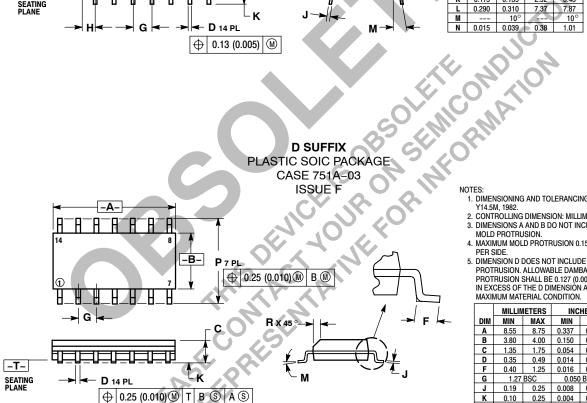




- NOTES:
  1. DIMENSIONING AND TOLERANCING PER ANSI
- Y14.5M, 1982. CONTROLLING DIMENSION: INCH.
- DIMENSION L TO CENTER OF LEADS WHEN
- FORMED PARALLEL.
- DIMENSION B DOES NOT INCLUDE MOLD FLASH.
   ROUNDED CORNERS OPTIONAL.

	INC	HES	MILLIN	IETERS
DIM	MIN	MAX	MIN	MAX
Α	0.715	0.770	18.16	18.80
В	0.240	0.260	6.10	6.60
С	0.145	0.185	3.69	4.69
D	0.015	0.021	0.38	0.53
F	0.040	0.070	1.02	1.78
G	0.100	BSC	2.54 BSC	
Н	0.052	0.095	1.32	2.41
J	0.008	0.015	0.20	0.38
K	0.115	0.135	2.92	3.43
L	0.290	0.310	7.37	7.87
M		10°	4	10°
N	0.015	0.039	0.38	1.01





- NOTES:
  1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
  2. CONTROLLING DIMENSION: MILLIMETER.
- DIMENSIONS A AND B DO NOT INCLUDE MOLD PROTRUSION.
- 4. MAXIMUM MOLD PROTRUSION 0.15 (0.006)
- PEH SIDE.

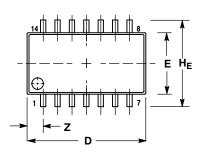
  5. DIMENSION D DOES NOT INCLUDE DAMBAR
  PROTRUSION. ALLOWABLE DAMBAR
  PROTRUSION SHALL BE 0.127 (0.005) TOTAL
  IN EXCESS OF THE D DIMENSION AT
  MAXIMUM MATERIAL CONDITION.

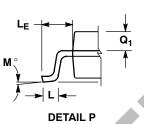
	MILLIN	IETERS	INCHES		
DIM	MIN	MAX	MIN	MAX	
Α	8.55	8.75	0.337	0.344	
В	3.80	4.00	0.150	0.157	
С	1.35	1.75	0.054	0.068	
D	0.35	0.49	0.014	0.019	
F	0.40	1.25	0.016	0.049	
G	1.27 BSC		0.050 BSC		
J	0.19	0.25	0.008	0.009	
K	0.10	0.25	0.004	0.009	
M	0 °	7°	0°	7°	
Р	5.80	6.20	0.228	0.244	
R	0.25	0.50	0.010	0.019	

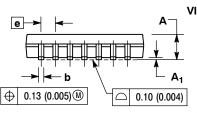
#### PACKAGE DIMENSIONS

#### **M SUFFIX**

SOEIAJ PACKAGE CASE 965-01 **ISSUE O** 









- 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
- CONTROLLING DIMENSION: MILLIMETER.
  DIMENSIONS D AND E DO NOT INCLUDE MOLD FLASH OR PROTRUSIONS AND ARE MEASURED AT THE PARTING LINE. MOLD FLASH OR PROTRUSIONS SHALL NOT EXCEED 0.15 (0.006) PER SIDE.
- TERMINAL NUMBERS ARE SHOWN FOR REFERENCE ONLY. THE LEAD WIDTH DIMENSION (b) DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.08 (0.003) TOTAL IN EXCESS OF THE LEAD WIDTH DIMENSION AT MAXIMUM MATERIAL CONDITION DAMBAR CANNOT BE LOCATED ON THE LOWER RADIUS OR THE FOOT. MINIMUM SPACE BETWEEN PROTRUSIONS AND ADJACENT LEAD TO BE 0.46 ( 0.018).

	MILLIN	IETERS	INC	HES
DIM	MIN	MAX	MIN	MAX
Α	-	2.05		0.081
A <sub>1</sub>	0.05	0.20	0.002	0.008
b	0.35	0.50	0.014	0.020
C	0.18	0.27	0.007	0.011
D	9.90	10.50	0.390	0.413
E	5.10	5.45	0.201	0.215
е	1.27 BSC		0.050 BSC	
HE	7.40	8.20	0.291	0.323
0.50	0.50	0.85	0.020	0.033
ĹE.	1.10	1.50	0.043	0.059
N	0 °	10°	0 °	10°
Q	0.70	0.90	0.028	0.035
Z		1.42		0.056

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